

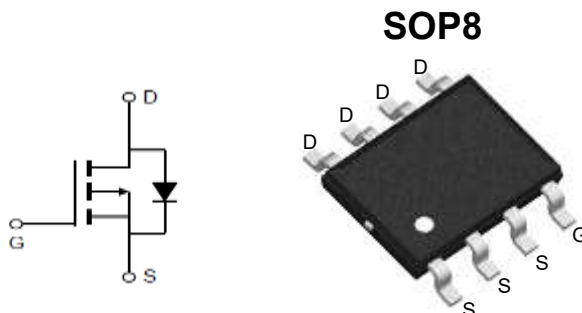
-30V_{DS}/±20V_{GS} P-Channel Advanced Mode MOSFET

Features

- $V_{DS}=-30V, I_D=-9A$
- $R_{DS(ON)}=25m\Omega$ (TYP.) $V_{GS}=-10V$
- $R_{DS(ON)}=40m\Omega$ (TYP.) $V_{GS}=-4.5V$
- Fast Switching
- Low On-Resistance

Applications

- Switch switching
- Power management in portable/desktop PCs



Ordering Information

Device	package	Device Marking	Package Qty.
HM9435	SOP-8	M9435	3000/PCS

Absolute Maximum Ratings (T_a=25℃, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	-30	V
Gate-Source Voltage (V _{GS} =0V,static)	V _{GS}	±20	V
Continuous Drain Current (T _a =25℃)	I _D	-9	A
Continuous Drain Current (T _a =70℃)		-6	A
Pulsed Drain Current	I _{DM}	-36	A
Avalanche Energy, Single Pulsed	E _{AS}	-	mJ
Maximum Power Dissipation (T _a =25℃)	P _D	3.1	W
Operating,Storage Temperature Range	T _J ,T _{STG}	-55~150	℃

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V	-	-	-1	μA
Gate -Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250μA	-1.0	-1.5	-2.5	V
Drain-Source On-stage Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-1A	-	19	25	mΩ
		V _{GS} =-4.5V, I _D =-1A	-	25	40	

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	-	40	-	$^{\circ}\text{C}/\text{W}$
Thermal Resistance,Junction-to-Ambient	$R_{\theta JA}$	-	24	-	$^{\circ}\text{C}/\text{W}$

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C_{iss}	$V_{DS}=-15\text{V}$	-	1150	-	pF
Output capacitance	C_{oss}	$V_{GS}=0\text{V}$	-	150	-	
Reverse transfer capacitance	C_{rss}	$f=1\text{MHz}$	-	135	-	
Gate Resistance	R_g	$f=1\text{MHz}$	-	-	-	Ω
Total Gate Charge	Q_g	$V_{DS}=-15\text{V}$	-	52	-	nC
Gate Source Charge	Q_{gs}	$V_{GS}=-10\text{V}$	-	9.8	-	
Gate Drain Charge	Q_{gd}	$I_D=-15\text{A}$	-	8.3	-	
Turn-on delay Time	$t_{d(on)}$	$V_{GS}=-10\text{V}$	-	13	-	ns
Rise time	t_r	$V_{DS}=-15\text{V}$	-	15	-	
Turn-off delay Time	$t_{d(off)}$	$R_L=1\Omega$	-	198	-	
Fall time	t_f	$R_G=3\Omega$	-	98	-	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_{SD}=-1\text{A}$	-	-	-1.2	V
Reverse Recovery Time	t_{rr}	$V_{GS}=0\text{V}, I_{SD}=-15\text{A}$ $d_i/d_t=100\text{A}/\mu\text{s}$	-	37	-	ns

Electrical Characteristics Diagrames

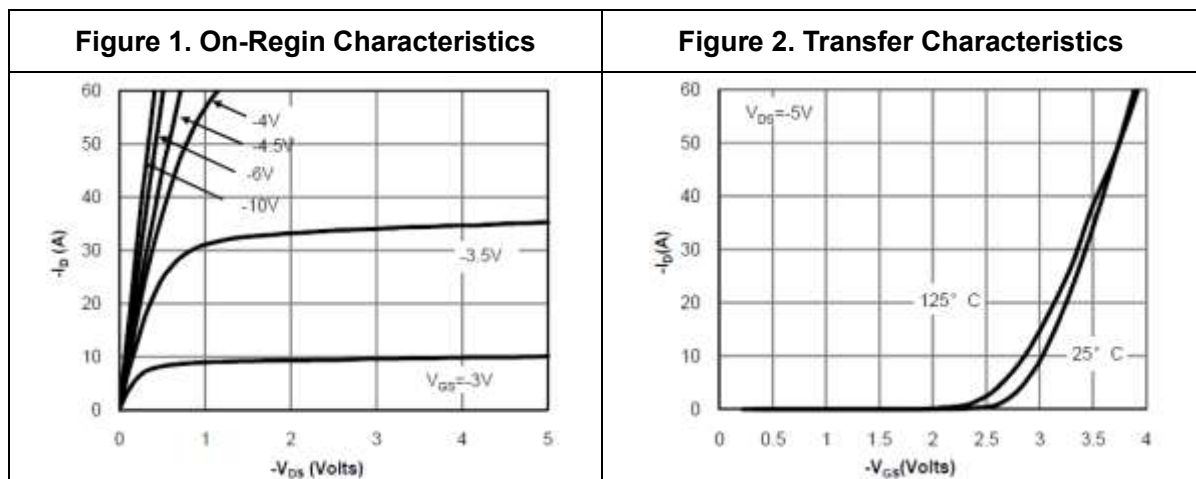


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

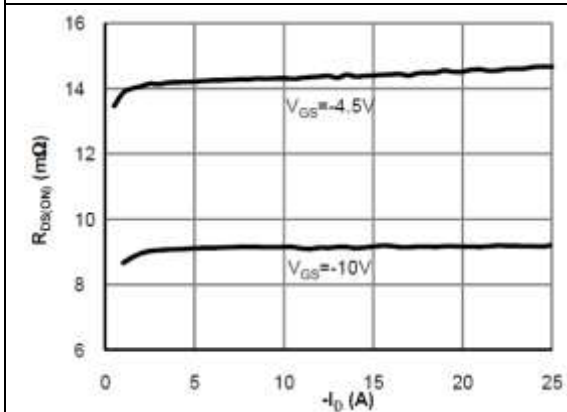


Figure 4. On-Resistance vs. Junction Temperature

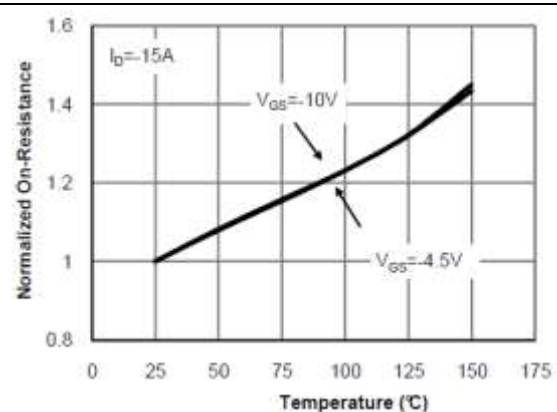


Figure 5. On-Resistance vs. Gate-Source Voltage

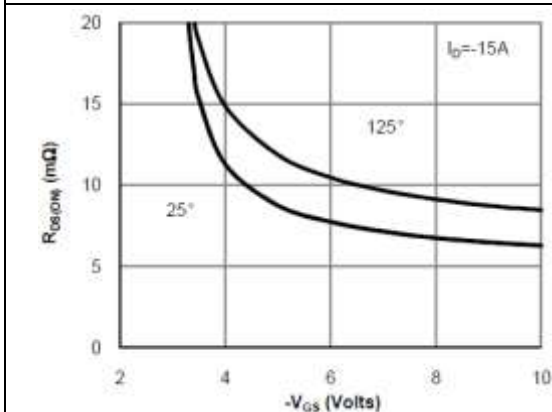


Figure 6. Body-Diode Characteristics

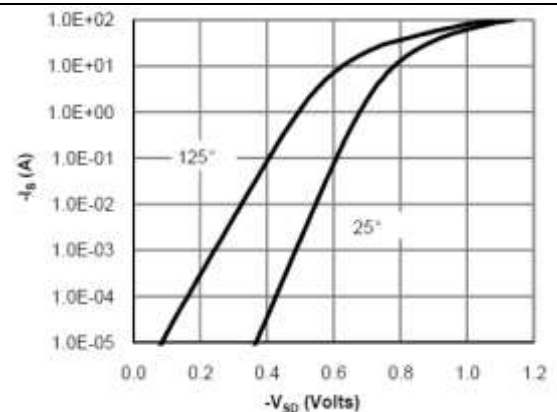


Figure 7. Gate-Charge Characteristics

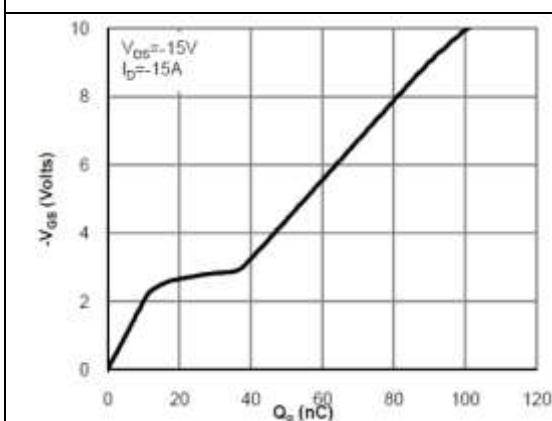


Figure 8. Capacitance Characteristics

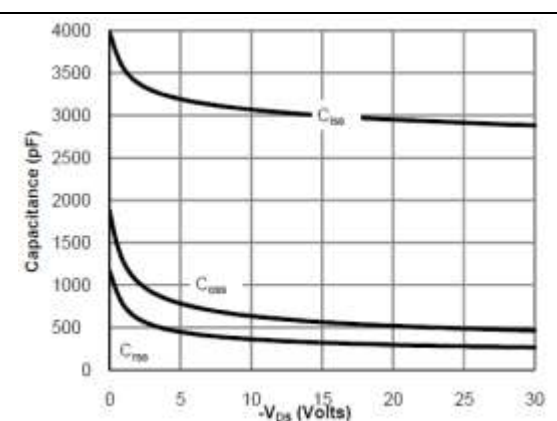


Figure 9. Maximum Forward Biased Safe Operating Area

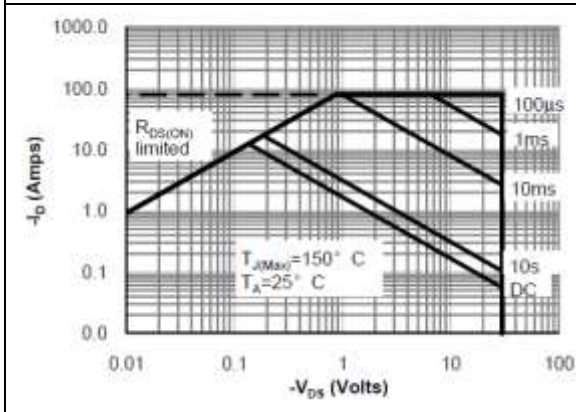


Figure 10. Single Pulse Power Rating Junction-to-Ambient

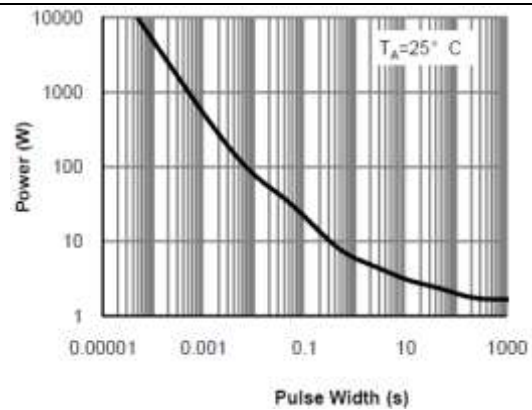
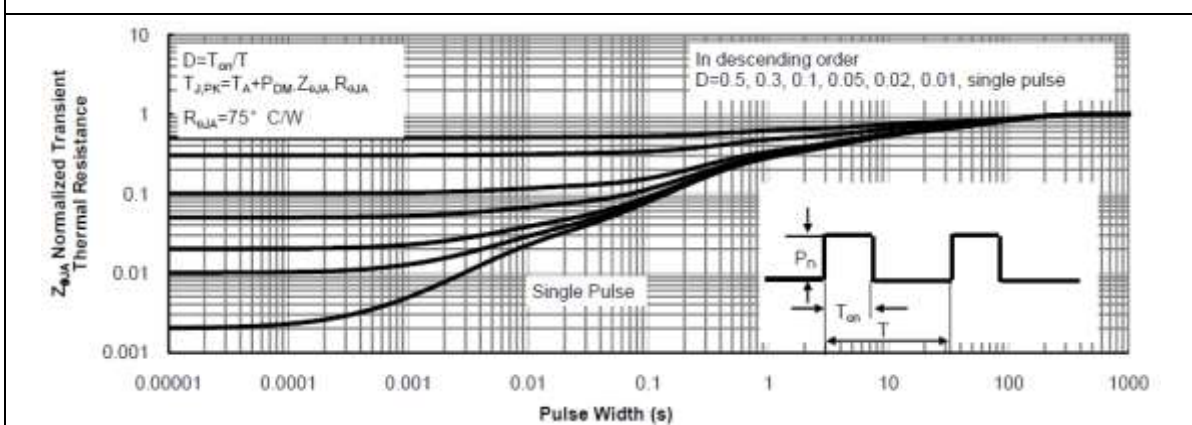
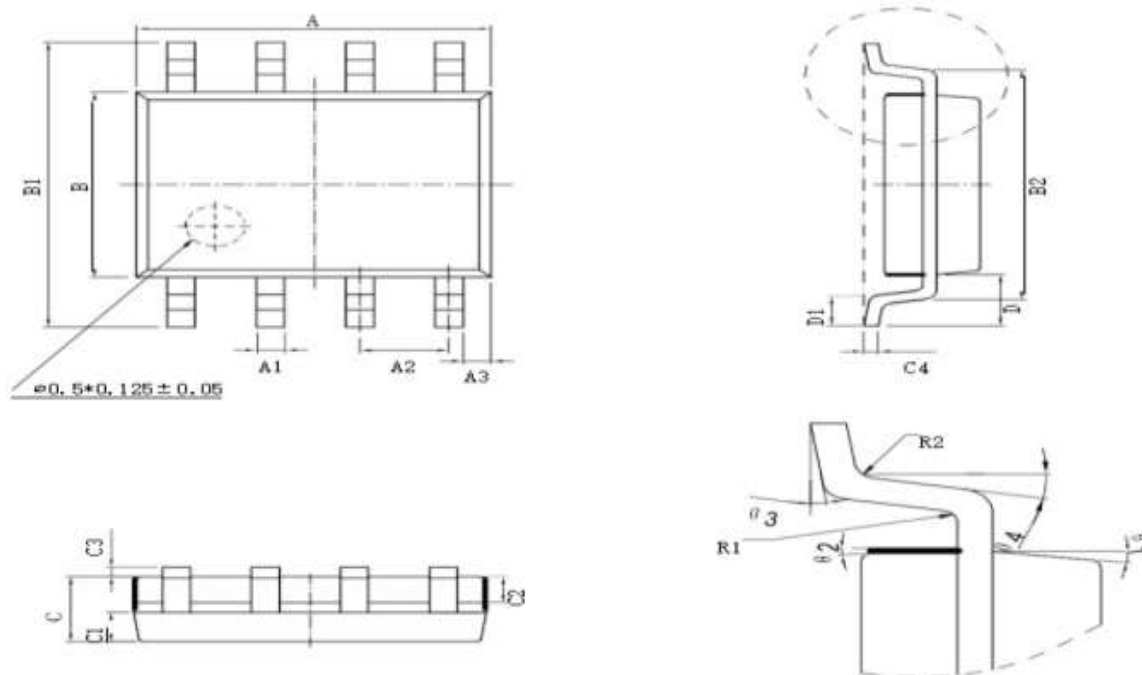


Figure 11. Normalized Maximum Transient Thermal Impedance



Physical Dimensions

SOP8



符号	尺寸 (mm)		符号	尺寸 (mm)	
	最小值	最大值		最小值	最大值
A	4.80	5.00	C3	0.05	0.20
A1	0.356	0.456	C4	0.203	0.233
A2	1.27 TYP		D	1.05 TYP	
A3	0.345 TYP		D1	0.40	0.80
B	3.80	4.00	R1	0.20 TYP	
B1	5.80	6.20	R2	0.20 TYP	
B2	5.00 TYP		θ1	17° TYP4	
C	1.30	1.60	θ2	13° TYP4	
C1	0.55	0.65	θ3	0° ~ 8°	
C2	0.55	0.65	θ4	4° ~ 12°	

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